

# 26 V, 4-Channel Voltage Bus and 4-Channel High-Side Current Shunt Monitor

# NCP45495

The NCP45495 is a high-performance monolithic IC which can be used to monitor bus voltage and current on four high-voltage power supplies simultaneously. The HV bus voltages and currents are translated to a low-voltage power domain and multiplexed onto a single differential output for measurement externally by common ADCs. The NCP45495 offers programmable voltage and current gain settings and requires a minimal amount of external passives for a small cost saving solution. The device is also configurable to operate either standalone or as a pair, permitting up to eight separate HV power supplies to be monitored and measured.

#### **Features**

- Translates and Scales Shunt and Bus Voltages up to 26 V
- Single Device Monitors Four Supplies
- May Be Paired for Monitoring Up To Eight Supplies
- Very Low Powerdown Current
- All Channels Individually Gain Programmable via I<sup>2</sup>C Interface
- Fast Settling Time
- Real-Time Bus Voltages Valid Signal
- Adjustable Output Common-Mode Voltage
- RoHS/REACH Compliant Device

#### **Applications**

- Computers / Notebooks / Graphics Cards
- Power Management / Power Control Loops
- Battery Chargers



#### MARKING DIAGRAM

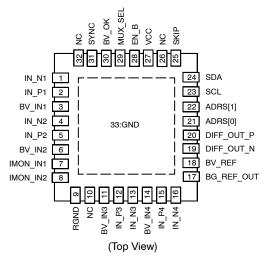


45495 = Specific Device Code

A = Assembly Location L = Wafer Lot

Y = Year W = Work Week • Pb-Free Package

# **PIN CONFIGURATION**



#### **ORDERING INFORMATION**

| Device         | Package          | Shipping <sup>†</sup> |
|----------------|------------------|-----------------------|
| NCP45495XMNTWG | QFN32<br>(Green) | 4000 /<br>Tape & Reel |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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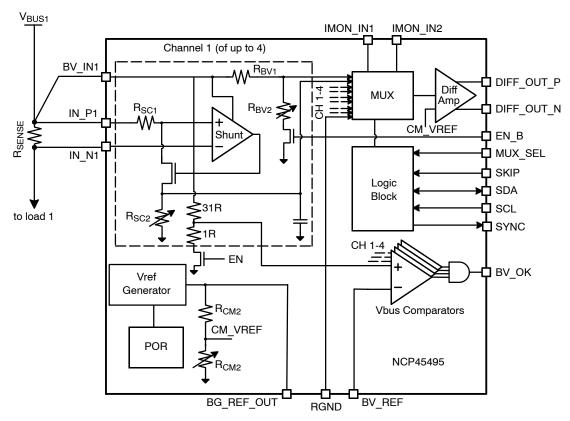


Figure 1. Block Diagram

**Table 1. PIN DESCRIPTION** 

| Pin       | Name       | I/O   | Function   |
|-----------|------------|-------|--|
| 1,4,13,16 | IN_Nx      | Al    | Sense Resistor Sense –, High Voltage   |
| 2,5,12,15 | IN_Px      | Al    | Sense Resistor Sense +, High Voltage   |
| 3,6,11,14 | BV_INx     | Al    | Bus Voltage Input for Voltage monitoring   |
| 7,8       | IMON_INx   | Al    | Current Monitor Channels (High impedance input)  |
| 9         | RGND       | GND   | Reference Ground for multiplexer and differential amplifier  |
| 17        | BG_REF_OUT | AO    | Buffered Bandgap Voltage Output  |
| 18        | BV_REF     | Al    | BV_OK comparator threshold reference   |
| 19        | DIFF_OUT_N | AO    | Differential Output, Negative  |
| 20        | DIFF_OUT_P | AO    | Differential Output, Positive  |
| 21,22     | ADRS[1:0]  | DI    | I <sup>2</sup> C Address set bits  |
| 23        | SCL        | DI    | I <sup>2</sup> C Clock   |
| 24        | SDA        | DI/DO | I <sup>2</sup> C Data Signal   |
| 25        | SKIP       | DI    | Skip Function control (see description) Mask for BV_OK. High level is V <sub>CC</sub> and low level is GND |
| 27        | VCC        | PWR   | Device Power   |
| 28        | EN_B       | DI    | Device Enable. When high, places device in low-power state.  |
| 29        | MUX_SEL    | DI    | Multiplexer Select Input   |
| 30        | BV_OK      | DO    | Bus OK output (open-drain; high impedance = BUS OK)  |
| 31        | SYNC       | DO    | Sync pin outputs a pulse at the beginning of every MUX_SEL sequence  |
| 33        | GND        | GND   | Device Ground  |

**Table 2. MAXIMUM RATINGS** 

| Rating  | Pins   | Condition | Symbol             | Value       | Unit |
|---|--|-----------|--------------------|-------------|------|
| Supply Voltage Range  | VCC  | GND = 0 V | V <sub>CC</sub>    | -0.3 to 5.5 | V    |
| Bus Input Voltage Range                                       | BV_INx, IN_Px, IN_Nx                         | GND = 0 V | V <sub>BV_IN</sub> | -0.3 to 30  | V    |
| Digital Input Voltage Range                                   | MUX_SEL, EN_B, SKIP, SCL,<br>SDA, ADRS[x]    | GND = 0 V | V <sub>LV</sub>    | -0.3 to 5.5 | V    |
| Low Voltage I/O Range   | DIFF_OUT_P, DIFF_OUT_N,<br>BV_OK, BG_REF_OUT | GND = 0 V | $V_{LV}$           | -0.3 to 5.5 | V    |
| Thermal Resistance, Junction-to-Air                           |  |           | $R_{\theta JA}$    | 40          | °C/W |
| Thermal Resistance, Junction-to-Case (V <sub>IN</sub> Paddle) |  |           | $R_{	heta JC}$     | 5           | °C/W |
| Operating Temperature Range                                   |  |           | T <sub>A1</sub>    | -40 to 105  | °C   |
| Functional Temperature Range                                  |  |           | T <sub>A2</sub>    | -40 to 125  | °C   |
| Maximum Junction Temperature                                  |  |           | $T_J$              | 125         | °C   |
| Storage Temperature Range                                     |  |           | T <sub>STG</sub>   | -40 to 150  | °C   |
| Lead Temperature, Soldering (10 sec.)                         |  |           | T <sub>SLD</sub>   | 260         | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **Table 3. ESD RATINGS**

| Rating  | Symbol             | Value | Unit |
|---|--------------------|-------|------|
| ESD Capability, Human Body Model (Note 1)     | ESD <sub>HBM</sub> | >2.0  | kV   |
| ESD Capability, Charged Device Model (Note 1) | ESD <sub>CDM</sub> | >0.5  | kV   |

1. Tested by the following methods @ T<sub>A</sub> = 25 °C ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)

ESD Charged Device Model per JESD22-C101

# **Table 4. RECOMMENDED OPERATING RANGES**

| Rating                                    | Symbol                                  | Min   | Max   | Unit |
|---|---|-------|-------|------|
| Supply Voltage Range                      | V <sub>CC</sub>                         | 2.8   | 3.8   | V    |
| Bus Input Pin Voltage Range               | V <sub>IN_PX</sub> , V <sub>IN_Nx</sub> | 5     | 26    | V    |
| Digital Input High Voltage Range (Note 2) | V <sub>IH</sub>                         | 0.945 |       | V    |
| Digital Input Low Voltage Range (Note 2)  | V <sub>IL</sub>                         |       | 0.405 | V    |
| SKIP Input High Voltage Range             | SKIP <sub>VIH</sub>                     | 2.8   | 3.8   | V    |
| SKIP Input Low Voltage Range              | SKIP <sub>VIL</sub>                     |       | 0.405 | V    |
| Ambient Temperature                       | T <sub>A</sub>                          | -40   | 85    | °C   |
| Junction Temperature                      | T <sub>J</sub>                          | -40   | 125   | °C   |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

2. V<sub>IL</sub> and V<sub>IH</sub> ranges apply to the EN\_B, SCLK, SDA, ADRS[x], and MUX\_SEL pins

 $\textbf{Table 5. ELECTRICAL CHARACTERISTICS} \ V_{IN\_PX} = 15 \ V, \ V_{EN\_B} = 0 \ V, \ Vcc = 3.3 \ V, \ unless indicated otherwise. Min and Max values are valid for temperature range -40 °C < T_J < +105 °C unless noted otherwise and are guaranteed by test, design,$ characterization, or statistical correlation. Typical values are referenced to T<sub>J</sub> = 25 °C

| Parameter  | Symbol              | Min   | Тур  | Max   | Unit      |
|--|---------------------|-------|------|-------|-----------|
| AC CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise specified) |                     |       | •    |       | •         |
| Multiplexer Settling Time (to 9.375 mV)                                | T <sub>STAB1</sub>  |       |      | 100   | ns        |
| Multiplexer Settling Time (to 3 mV)                                    | T <sub>STAB2</sub>  |       |      | 300   | ns        |
| MUX_SEL Period (normal operation – assuming no timeout set) (Note 12)  | T <sub>MSP</sub>    | 0.185 |      | 11    | μs        |
| MUX_SEL Duty Cycle (nominal)   | D_MUX_SEL           | 45    | 50   | 55    | %         |
| MUX_SEL Timeout (from falling edge of MUX_SEL)                         |                     | 35    | 39   | 43    | μs        |
| Power-up Time (STANDBY or Limited Function to Full Function) (Note 3)  | T <sub>PWR_UP</sub> |       |      | 40    | μs        |
| Differential Amplifier Capacitive Load Capability (Note 4)             | C <sub>DIFF</sub>   |       |      | 82    | pF        |
| DC CHARACTERISTICS   |                     |       |      |       |           |
| Input Impedance (EN_B pin tri-stated)                                  | R <sub>FLOAT</sub>  | 100k  |      |       | Ω         |
| IMONx Channel Input Leakage Current                                    |                     |       |      | 100   | nA        |
| BG_REF_OUT Voltage   | $V_{BG}$            | 1.274 | 1.3  | 1.326 | V         |
| BG_REF_OUT maximum loading   | I <sub>BG</sub>     |       |      | 100   | μΑ        |
| BV_OK Logic Low Impedance (Note 5)                                     | R <sub>BV_OK</sub>  |       |      | 300   | Ω         |
| BV_REF Voltage Range   | BV_REF              | 100   |      | 800   | mV        |
| BV_OK Comparator Hysteresis  |                     | 7.5   | 10   | 12.5  | %         |
| BV_OK Comparator VBUS divide ratio                                     |                     |       | 1/32 |       | V/V       |
| VCC range for BV_OK low impedance                                      | $V_{LI}$            | 1     |      | 3.8   | V         |
| VCC Threshold Reference for BV_OK Input (POR) (Note 6)                 | V <sub>BV_TH</sub>  | 2.6   |      | 2.8   | V         |
| POR Hysteresis   |                     |       | 150  |       | mV        |
| Shunt Monitor Offset Voltage, room temp (Note 7)                       | V <sub>SM_OV</sub>  | -150  |      | 150   | μV        |
| Shunt Monitor Offset Voltage Drift (Note 7)                            | SM_VD               |       |      | 2     | μV/°C     |
| Shunt Monitor CMRR (V <sub>IN_Px</sub> in valid range, see above)      | SM_CMRR             | 80    |      |       | dB        |
| Shunt Current Gain Range (See Table 6)                                 |                     | 2     |      | 24    | V/V       |
| Shunt Current Gain Tolerance (Note 11)                                 |                     |       |      | 0.6   | %         |
| Differential Amp Input Offset Voltage, 25 °C (Note 8)                  | $V_{D\_OVRT}$       | -2    |      | 2     | mV        |
| Differential Amp Input Offset Voltage, -40 °C to 105 °C (Note 8)       | V <sub>D_OVT</sub>  | -6    |      | 6     | mV        |
| Differential Amp PSRR (V <sub>CC</sub> = 2.8 V to 3.8 V)               | DA_PSRR             | 54    |      |       | dB        |
| Differential Amp Common-Mode Voltage                                   | $V_{CMR}$           | 575   |      | 875   | mV        |
| Differential Amp Closed Loop Gain (Note 11)                            | G <sub>DA</sub>     | 0.994 | 1    | 1.006 | V/V       |
| Differential Full Scale Output   | V <sub>FSO</sub>    |       |      | 800   | $mV_{pp}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 3. TPWR UP begins when EN\_B goes low. After the power up time, MUX\_SEL may begin clocking out data. This time also applies following any register programming.
- 4. Differential Output  $C_{LOAD}$  (i.e.: DIFF\_OUT\_x to GND) appears as a series RC with lumped equivalent R (0.86-8.6  $\Omega$ )
- 5. BV\_OK should be connected to a pull up resistor of value 10 K $\Omega$  or greater.
- Vcc detection for BV\_OK must trip in this range. Device can be either Full Function or Limited Function mode in this range
   Shunt Monitor Offset Voltage and Offset Voltage Drift are referred to the IN\_Px and IN\_Nx pins.
- 8. Differential Amplifier Input Offset Voltage is referred to the multiplexer input pins
- 9. V<sub>EN</sub> = V<sub>CC</sub>; Total V<sub>CC</sub> standby current is I<sub>VCC</sub> s for every IN\_Px channel that is not floating
- 10. Specifications for V<sub>BUS</sub> current draw are only applicable when V<sub>CC</sub> = 2.8 V to 3.8 V.
- 11. 3-sigma variation specification
- 12. Avoid running MUX\_SEL in the potential aliasing frequency ranges when Timeout is enabled. [1.8 MHz to 2.1 MHz] and [3.6 MHz to 4.2 MHz]

**Table 5. ELECTRICAL CHARACTERISTICS**  $V_{IN\_PX} = 15 \text{ V}, V_{EN\_B} = 0 \text{ V}, V_{CC} = 3.3 \text{ V}, \text{ unless indicated otherwise. Min and Max values are valid for temperature range <math>-40 \text{ }^{\circ}\text{C} < \text{T}_{J} < +105 \text{ }^{\circ}\text{C}$  unless noted otherwise and are guaranteed by test, design, characterization, or statistical correlation. Typical values are referenced to  $T_{J} = 25 \text{ }^{\circ}\text{C}$ 

| Parameter   | Symbol               | Min  | Тур | Max | Unit |
|---|----------------------|------|-----|-----|------|
| DC CHARACTERISTICS  |                      |      |     |     |      |
| I_VCC (Fully Functional, EN_B = 0, MUX_SEL clocked at 2 MHz, VCC must be 2.8 V - 3.8 V) | I <sub>VCC_F</sub>   |      |     | 2.0 | mA   |
| I_VCC (Limited Function, EN_B=Tristate, VCC must be 2.8 V = 3.8 V)                      | I <sub>VCC_L</sub>   |      |     | 400 | μΑ   |
| I_VCC (STANDBY) (Note 9)  | I <sub>VCC_S</sub>   |      |     | 200 | μΑ   |
| I_BV_IN (BV_IN current in STANDBY mode)   | I <sub>BV_IN_S</sub> |      |     | 2   | μΑ   |
| I_BV_IN (BV_IN current in LIMITED mode)   | I <sub>BV_IN_L</sub> |      |     | 120 | μΑ   |
| I_BV_IN (BV_IN current in Full Function)  | I <sub>BV_IN_F</sub> |      |     | 600 | μΑ   |
| I_BV_IN (BV_IN current when VCC = FLOATING)   | I <sub>BV_IN</sub>   |      |     | 2   | μΑ   |
| I_IN_N (IN_N current in STANDBY/LIMITED mode) (Note 10)                                 | I <sub>IN_N</sub>    |      |     | 1   | μΑ   |
| I_IN_P (IN_P current in STANDBY/LIMITED mode) (Note 10)                                 | I <sub>IN_P</sub>    |      |     | 1   | μΑ   |
| I_IN_N (IN_N current in Full Function mode) (Note 10)                                   |                      |      |     | 60  | μΑ   |
| I_IN_P (IN_P current in Full Function mode mode) (Note 10)                              |                      |      |     | 60  | μΑ   |
| V <sub>BUS</sub> Gain Range   |                      | 1/64 |     | 1/4 | V/V  |
| V <sub>BUS</sub> Gain Tolerance   |                      |      |     | 0.6 | %    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 3. T<sub>PWR\_UP</sub> begins when EN\_B goes low. After the power up time, MUX\_SEL may begin clocking out data. This time also applies following any register programming.
- 4. Differential Output  $C_{LOAD}$  (i.e.: DIFF\_OUT\_x to GND) appears as a series RC with lumped equivalent R (0.86-8.6  $\Omega$ )
- 5. BV\_OK should be connected to a pull up resistor of value 10 K $\Omega$  or greater.
- 6. Vcc detection for BV OK must trip in this range. Device can be either Full Function or Limited Function mode in this range
- 7. Shunt Monitor Offset Voltage and Offset Voltage Drift are referred to the IN Px and IN Nx pins.
- 8. Differential Amplifier Input Offset Voltage is referred to the multiplexer input pins
- 9. V<sub>EN</sub> = V<sub>CC</sub>; Total V<sub>CC</sub> standby current is I<sub>VCC</sub> s for every IN\_Px channel that is not floating
- 10. Specifications for  $V_{BUS}$  current draw are only applicable when  $V_{CC}$  = 2.8 V to 3.8 V.
- 11. 3-sigma variation specification
- 12. Avoid running MUX\_SEL in the potential aliasing frequency ranges when Timeout is enabled. [1.8 MHz to 2.1 MHz] and [3.6 MHz to 4.2 MHz]

#### **DETAILED DESCRIPTION**

Differential Output Amplifier: An integrated differential output amplifier provides a scaled representation of multiple bus voltages and currents to an external ADC on the DIFF OUT P and DIFF OUT N pins. These voltages and currents are presented sequentially (under control of the Sequence Logic block) via the Multiplexer. The gain of the differential amplifier is 1 V/V. The common-mode voltage of the differential output amplifier is established by an internal reference divider. The common mode voltage is programmable from 575 mV to 875 mV in 25 mV increments to offer flexibility for the ADC reading the differential outputs. The contents of the DIFF AMP CM register set the differential amplifier common mode voltage. The offset of the differential amplifier is also programmable by setting the DIFF\_AMP\_OFFSET register. The differential offset can be set to 0 mV or from -325 to -375 mV in 25 mV increments. See the DIFF AMP register description in the I<sup>2</sup>C interface definition section for more details.

# **Shunt Current Monitor (one of four identical instances):**

The differential voltage across an external sense resistor (R<sub>SENSE</sub>) is converted to a current by a transconductor stage implemented by an op-amp and an internal shunt resistor R<sub>SC1</sub>. The current is forced through a programmable internal resistor R<sub>SC2</sub> to create the internal shunt voltage. The resulting voltage is fed into the multiplexer for readout. The conversion gain can be programmed to gains from 2x to 24x. The SHUNT\_GAINx registers are used to set the shunt current gains for each channel. The voltage represented on the differential output for the shunt current is the voltage drop across the external sense resistor multiplied by the shunt gain.

Diff Output = Iload \* Rsense \* shunt gain

The table below shows the available shunt gain settings.

Table 6. SHUNT CURRENT PROGRAMMABLE GAIN SETTINGS

| SHUNT_GAIN<br>(Bits 5-1) | Register Contents (includes bit 0) | Shunt Current<br>Channel Gains |
|--------------------------|------------------------------------|--------------------------------|
| 0b'11111                 | 0x3E                               | 24.000                         |
| 0b'11110                 | 0x3C                               | 22.151                         |
| 0b'11101                 | 0x3A                               | 20.445                         |
| 0b'11100                 | 0x38                               | 18.870                         |
| 0b'11011                 | 0x36                               | 17.417                         |
| 0b'11010                 | 0x34                               | 16.075                         |
| 0b'11001                 | 0x32                               | 14.837                         |
| 0b'11000                 | 0x30                               | 13.694                         |
| 0b'10111                 | 0x2E                               | 12.639                         |
| 0b'10110                 | 0x2C                               | 11.665                         |
| 0b'10101                 | 0x2A                               | 10.767                         |
| 0b'10100                 | 0x28                               | 9.937                          |
| 0b'10011                 | 0x26                               | 9.172                          |
| 0b'10010                 | 0x24                               | 8.465                          |
| 0b'10001                 | 0x22                               | 7.813                          |
| 0b'10000                 | 0x20                               | 7.212                          |
| 0b'01111                 | 0x1E                               | 6.656                          |
| 0b'01110                 | 0x1C                               | 6.143                          |
| 0b'01101                 | 0x1A                               | 5.670                          |
| 0b'01100                 | 0x18                               | 5.233                          |
| 0b'01011                 | 0x16                               | 4.830                          |
| 0b'01010                 | 0x14                               | 4.458                          |
| 0b'01001                 | 0x12                               | 4.115                          |
| 0b'01000                 | 0x10                               | 3.798                          |
| 0b'00111                 | 0x0E                               | 3.505                          |
| 0b'00110                 | 0x0C                               | 3.235                          |
| 0b'00101                 | 0x0A                               | 2.986                          |
| 0b'00100                 | 0x08                               | 2.756                          |
| 0b'00011                 | 0x06                               | 2.544                          |
| 0b'00010                 | 0x04                               | 2.348                          |
| 0b'00001                 | 0x02                               | 2.167                          |
| 0b'00000                 | 0x00                               | 2.000                          |
|                          |                                    |                                |

Bus Voltage Monitor (one of four identical instances): An internal voltage divider ( $R_{BV1}$  and  $R_{BV2}$ ) is used to scale the voltage on the BV\_INx pin to an appropriate full-scale range for the differential output amplifier. The voltage divider is programmable from 1/4(V/V) to 1/64(V/V) as shown in the table below. BUS\_GAINx registers are used to set the voltage gains for each channel. The differential output voltage representing the bus voltage is the bus voltage divided by the VBUS attenuation.

Diff Output = 
$$\frac{V_{BUS}}{A_V}$$

Table 7. VBUS PROGRAMMABLE ATTENUATION SETTINGS

| BUS_GAIN<br>(Bits 5-1) | Register Contents (includes bit 0) | VBUS Attenuation<br>Setting (A <sub>V</sub> ) |
|------------------------|------------------------------------|---|
| 0b'00000               | 0x00                               | 64.00   |
| 0b'00001               | 0x02                               | 58.524  |
| 0b'00010               | 0x04                               | 53.517  |
| 0b'00011               | 0x06                               | 48.939  |
| 0b'00100               | 0x08                               | 44.752  |
| 0b'00101               | 0x0A                               | 40.923  |
| 0b'00110               | 0x0C                               | 37.422  |
| 0b'00111               | 0x0E                               | 34.220  |
| 0b'01000               | 0x10                               | 31.292  |
| 0b'01001               | 0x12                               | 28.615  |
| 0b'01010               | 0x14                               | 26.167  |
| 0b'01011               | 0x16                               | 23.928  |
| 0b'01100               | 0x18                               | 21.881  |
| 0b'01101               | 0x1A                               | 20.009  |
| 0b'01110               | 0x1C                               | 18.297  |
| 0b'01111               | 0x1E                               | 16.732  |
| 0b'10000               | 0x20                               | 15.300  |
| 0b'10001               | 0x22                               | 13.991  |
| 0b'10010               | 0x24                               | 12.794  |
| 0b'10011               | 0x26                               | 11.700  |
| 0b'10100               | 0x28                               | 10.699  |
| 0b'10101               | 0x2A                               | 9.783   |
| 0b'10110               | 0x2C                               | 8.946   |
| 0b'10111               | 0x2E                               | 8.181   |
| 0b'11000               | 0x30                               | 7.481   |
| 0b'11001               | 0x32                               | 6.841   |
| 0b'11010               | 0x34                               | 6.256   |
| 0b'11011               | 0x36                               | 5.720   |
| 0b'11100               | 0x38                               | 5.231   |
| 0b'11101               | 0x3A                               | 4.783   |
| 0b'11110               | 0x3C                               | 4.374   |
| 0b'11111               | 0x3E                               | 4.000   |

# High Impedance Voltage Monitor (one of two identical instances):

The voltage on the IMON\_INx pin is fed directly to the multiplexer for readout. The differential output voltage represents the voltage on the IMON INx pin.

Multiplexer Select: The multiplexer selection is controlled by a single digital input (MUX\_SEL pin). The device will monitor this pin and cycle through the different measured parameters in a fixed sequence. The sequence will repeat the cycle until either a timeout condition is detected or the device is disabled. If the timeout is disabled, then MUX\_SEL must be clocked through the whole sequence before the cycle will repeat.

# MUX\_SEL Timeout

The MUX\_SEL timeout can be enabled or disabled over the I<sup>2</sup>C interface. If enabled, after 43 µs of idle time (from last falling edge of MUX\_SEL) on the MUX\_SEL pin the MUX\_SEL sequence is reset back to the beginning under the conditions in Note 12 in Table 5. All new register settings will become effective at the timeout. Writing 0b1 to the TIMEOUT register will disable the timeout. If the timeout is disabled, MUX\_SEL must be clocked to complete the full sequence before the cycle will repeat.

Paired Devices: In paired operation, programmed bits in the MUX\_SEL\_SKIP register designate which device is "Device A" and "Device B" of a pair. Device A always goes first in the sequence. When paired, the differential output amplifiers of the two devices are expected to be "wire-or'ed" together, and the table logic insures that only one device will actively drive the output pins DIFF\_OUT\_P and DIFF\_OUT\_N at any given time. See description in the Auxiliary Functions section for details. When in paired mode, the configuration register settings for registers TIMEOUT, DIFF\_AMP\_OFFSET and DIFF\_AMP\_CM must match between the 2 devices.

# **Power-up Sequence**

Correct functionality of the power monitor is not dependent on a specific power up sequence. All used bus voltages and VCC must be powered before the output will be correct. The ACTIVE\_CHAN register must be set over the I<sup>2</sup>C interface after VCC is up to set the active channel count. MUX\_SEL may begin clocking out data 40us after EN\_B goes low. Before the part is configured, BV\_OK will function with all VBUS channels considered active. Because all VBUS channels are active by default until otherwise configured, if BV\_OK functionality is used before the part is configured, un-used VBUS inputs should be tied to used VBUS inputs.

# **Calibration Cycle**

Setting bit 7 in the ACTIVE\_CHAN register adds an additional cycle at the end of the standard MUX\_SEL cycles. During this cycle, the device ground (connected to

the RGND pin) is muxed through the signal chain. The resulting differential output represents the differential amplifier offset error. The RGND pin should be treated as a reference ground. The controller can use the RGND readout to cancel out remaining offset error if desired. The calibration cycle is disabled by default. If in paired mode with 2 devices, then a calibration cycle will be added to the end of the sequence from each individual contributing device respectively. See Figure 2 and Figure 10 for CAL cycle example.

# **Polarity Mode**

Setting bit 7 in the ALTERNATING\_MODE register puts the differential output in alternating polarity mode. In alternating polarity mode, the voltage and current readouts will be repeated with alternating differential amplifier input polarity. This allows the user to compute and cancel out any differential amplifier offset. An example of an output using polarity mode is shown in the application section. Polarity mode is disabled by default. If in paired mode, the alternating polarity cycles will be added for each individual device output.

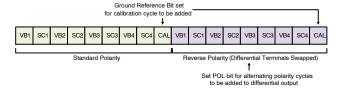


Figure 2. Sequence Showing Differential Output Format Options

# **SYNC Signal**

The SYNC output pin pulses high for the first MUX\_SEL period in a MUX\_SEL sequence beginning with the second MUX\_SEL sequence and continuing for all subsequent cycles. This is useful for the user to ensure synchronization, to guarantee the right channels are sampled at the right time. The SYNC pin is particularly useful for applications where MUX\_SEL is clocked continuously. When devices are used in paired mode, the SYNC signal for each device will be relative to its own position in the sequence.

# I<sup>2</sup>C INTERFACE DETAILS

The NCP45495 uses a 400 kHz, slave mode FM I<sup>2</sup>C interface for communication with an I<sup>2</sup>C master. The

purpose of the I<sup>2</sup>C interface is to provide access to configuration settings. Data packets for the power monitor I<sup>2</sup>C interface are sent with a 7 bit slave address, an 8 bit register address, a read / write bit, and 8 bits of data. Acknowledge bits are used after the addresses and data as a handshake verification. The address for the device can be set to one of 4 available addresses using the ADRS[1:0] pins. If in paired mode, Device A's address must be different than Device B's address. Continuous read and continuous write I<sup>2</sup>C modes, or combined formats are not supported by the NCP45495. Bits are always sent out MSB first.

The ADRS[1:0] address mapping is as follows:

| ADRS[1] | ADRS[0] | Set Device Address |
|---------|---------|--------------------|
| 0       | 0       | 0x34               |
| 0       | 1       | 0x35               |
| 1       | 0       | 0x36               |
| 1       | 1       | 0x37               |

It is recommended that all necessary registers are programmed while EN\_B is held high. On the falling edge of EN\_B, the programmed registers will be committed. On the first rising edge of the first MUX\_SEL, the register setting will be effective. If register settings are programmed after EN\_B has been asserted low, then the new settings will be effective at the beginning of the next MUX\_SEL cycle. If register settings are programed while MUX\_SEL is running, then the new settings will be effective on the rising edge of the first MUX\_SEL of the next cycle.

The I<sup>2</sup>C bus can also be locked by setting the appropriate bits in the LOCK register. Setting bit 1 will lock the I<sup>2</sup>C interface to any write commands. In this configuration, the device will respond to read commands, but not to write commands. Setting bit 0 will lock the I<sup>2</sup>C interface completely. In this configuration the device will not respond to any I<sup>2</sup>C activity. The device must be power cycled to get out of either of these locked states.

# **CONFIGURATION EXAMPLES**

Figure 3 below shows an example of a register write. In this example, the address pins of the NCP45495 are tied low, selecting address 0x34 as the slave address. The ACITVE\_CHAN register is written with 0x89, which will set channel 1 and channel 4 active, the ground reference is also enabled.

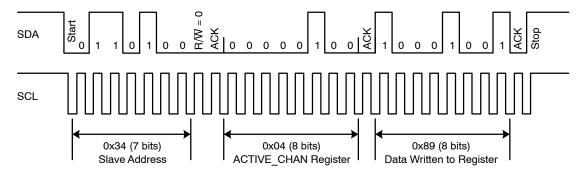


Figure 3. I<sup>2</sup>C Register Write Example

Figure 4 below shows an example of a register read with Repeated Start. In this example, the master reads 0x89 from the ACTIVE\_CHAN register.

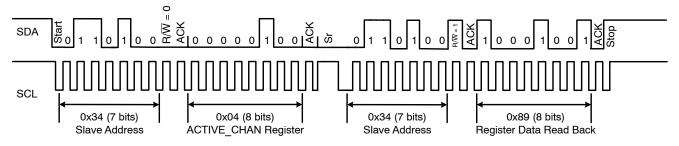


Figure 4. I<sup>2</sup>C Register Read with Repeated Start Example

Table 8. TIMING REQURIEMENTS: I<sup>2</sup>C INTERFACE

| Rating   | Symbol              | Min                 | Max | Unit |
|--|---------------------|---------------------|-----|------|
| SCL Clock Frequency  | F <sub>I2C</sub>    |                     | 0.4 | MHz  |
| Repeated hold time START condition (after this period, the first clock pulse is generated) | t <sub>HD,STA</sub> | 0.26                | -   | μs   |
| Data hold time   | t <sub>HD,DAT</sub> | 0                   | -   | μs   |
| LOW period of the SCL clock  | t <sub>LOW</sub>    | 0.5                 | -   | μs   |
| HIGH period of the SCL clock   | t <sub>HIGH</sub>   | 0.26                | ı   | μs   |
| Setup time for repeated start condition  | t <sub>SU,STA</sub> | 0.26                | ı   | μs   |
| Data setup time  | t <sub>SU;DAT</sub> | 50                  | ı   | ns   |
| Rise time for both SDA and SCL signals   | t <sub>r</sub>      | -                   | 300 | ns   |
| Fall time of both SDA and SCL signals  | t <sub>f</sub>      | 18.1                | 300 | ns   |
| Setup time for STOP condition  | t <sub>SU,STO</sub> | 0.26                | -   | μs   |
| Bus free time between a STOP and START condition   | t <sub>BUF</sub>    | 0.5                 | -   | μs   |
| Capacitive load for each bus line  | C <sub>B</sub>      | -                   | 550 | pF   |
| Noise margin at the LOW level for each connected device                                    | V <sub>nL</sub>     | 0.1*V <sub>CC</sub> | =   | V    |
| Noise margin at the HIGH level for each connected device                                   | V <sub>nH</sub>     | 0.2*V <sub>CC</sub> | -   | V    |

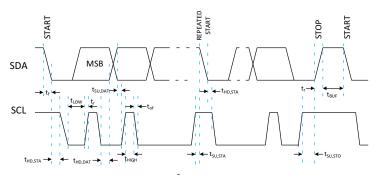


Figure 5. I<sup>2</sup>C Bus Timing

# Write Data Example

| 1 bit | 7 bits           | 1 bit | 1 bit | 8 bits                                   | 1 bit    | 8 bits  | 1 bit | 1 bit |
|-------|------------------|-------|-------|--|----------|---|-------|-------|
| s     | Slave<br>Address | R/W=0 | Α     | Register<br>Address                      | А        | DATA  | A/Ā   | Р     |
|       | From ma          |       |       | <ul> <li>Ā = N</li> <li>S = S</li> </ul> | lot ackr | edge (SDA lo<br>nowledge (SD<br>andition<br>ndition |       |       |

Figure 6. I<sup>2</sup>C Write Protocol Format

# **Read Data Example with Repeated Start**

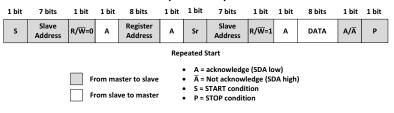


Figure 7. I<sup>2</sup>C Read with Repeated Start Format

The purposes and utilities of all accessible registers in the NCP45495 are detailed below. Addresses and bit assignments are explained.

# **Table 9. REGISTER MAP**

| Register<br>Address | Register Name   | Bits | R/W | Description   | Default<br>Setting | New Value<br>Takes Effect |
|---------------------|---|------|-----|---|--------------------|---------------------------|
| 0x00                | VendorID  | 7:0  | R   | onsemi Specific ID  | 0x4F               | N/A                       |
| 0x01                | DeviceID  | 7:0  | R   | NCP45495 Specific Device ID   | 0x2D               | N/A                       |
| 0x04                | ACTIVE_CHAN   | 7    | R/W | Enable Ground Reference   | 0                  | At next<br>MUX_SEL cycle  |
|                     |   | 5    | R/W | Enable iMon Channel 2   | 0                  | At next<br>MUX_SEL cycle  |
|                     |   | 4    | R/W | Enable iMon Channel 1   | 0                  | At next<br>MUX_SEL cycle  |
|                     |   | 3    | R/W | Enable Channel 4  | 1                  | At next<br>MUX_SEL cycle  |
|                     |   | 2    | R/W | Enable Channel 3  | 1                  | At next<br>MUX_SEL cycle  |
|                     |   | 1    | R/W | Enable Channel 2  | 1                  | At next<br>MUX_SEL cycle  |
|                     |   | 0    | R/W | Enable Channel 1  | 1                  | At next<br>MUX_SEL cycle  |
| 0x05                | MUX_SEL_SKIP  (set as 0x00 if operating in single device mode)  | 7:4  | R/W | Pulses to skip at the start of the MUX_SEL cycle (skipping pulses at the beginning defines device as device B in paired mode) | 0x0                | At next<br>MUX_SEL cycle  |
|                     |   | 3:0  | R/W | Pulses to skip at the end of the MUX_SEL cycle (skipping pulses at the end defines device as device A in paired mode)         | 0x0                | At next<br>MUX_SEL cycle  |
| 0x06                | ALTERNATING_MODE  | 7:7  | R/W | 0b1: Use Alternating Polarity Mode 0b0: Alternating Polarity Mode Disabled  | 0                  | At next<br>MUX_SEL cycle  |
| 0x07                | DIFF_AMP_OFFSET   | 1:0  | R/W | 0b11: -375 mV<br>0b10: -350 mV<br>0b01: -325 mV<br>0b00: 0 mV   | 0x0                | Immediately               |
| 0x08                | DIFF_AMP_CM Note: Differential output accuracy not guaranteed with V <sub>CMR</sub> below 575 mV. (Codes 0x0, 0x1, 0x2) | 3:0  | R/W | 0b1111: 875 mV<br>0b1110: 850 mV<br>0b0111: 675 mV<br>0b0100: 600 mV<br>0b0011: 575 mV  | 0x7<br>(675mV)     | Immediately               |
| 0x0F                | TIMEOUT   | 7:7  | R/W | 0b1: Disable Timeout<br>0b0: Timeout Active   | 0                  | Immediately               |
| 0x10                | BUS_GAIN1   | 5:1  | R/W | (Register contents: See Table 7)  | 0x00               | Immediately               |
| 0x11                | BUS_GAIN2   | 5:1  | R/W | 0x3E: 1/4   | (1/64)             |                           |
| 0x12                | BUS_GAIN3   | 5:1  | R/W | 0x00: 1/64  |                    |                           |
| 0x13                | BUS_GAIN4   | 5:1  | R/W | 1   |                    |                           |
| 0x20                | SHUNT_GAIN1   | 5:1  | R/W | (Register contents: See Table 6)  | 0x00               | Immediately               |
| 0x21                | SHUNT_GAIN2   | 5:1  | R/W | 0x3E: 24x   | (2x)               |                           |
| 0x22                | SHUNT_GAIN3   | 5:1  | R/W | 0x00: 2x  |                    |                           |
| 0x23                | SHUNT_GAIN4   | 5:1  | R/W | 1   |                    |                           |
| 0x24                | LOCK  | 1    | R/W | Lock I <sup>2</sup> C interface writes  | 0                  | Immediately               |
|                     |   | 0    | R/W | Lock I <sup>2</sup> C interface reads / writes  | 0                  | Immediately               |

# **APPLICATIONS DIAGRAMS**

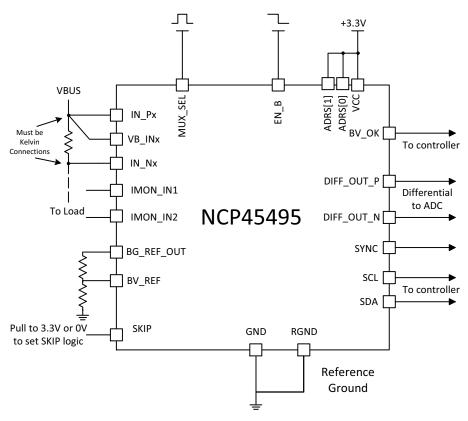


Figure 8. Stand Alone Device Typical Application Diagram

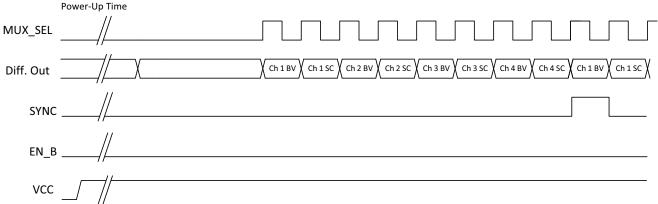


Figure 9. Stand Alone Signal Characteristics with all 4 Channels Activated

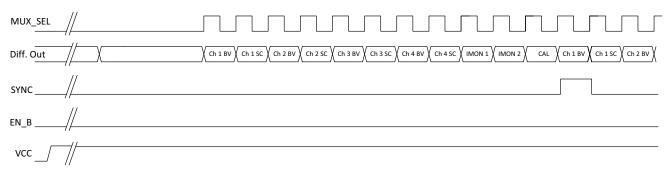


Figure 10. Stand Alone Signal Characteristics with IMON 1, IMON2, and Ground Reference Bits Set and all Channels Activated

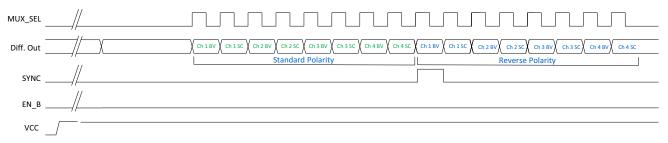


Figure 11. Stand Alone Signal Characteristics with ALTERNATING\_MODE Bit Set and all Channels Activated

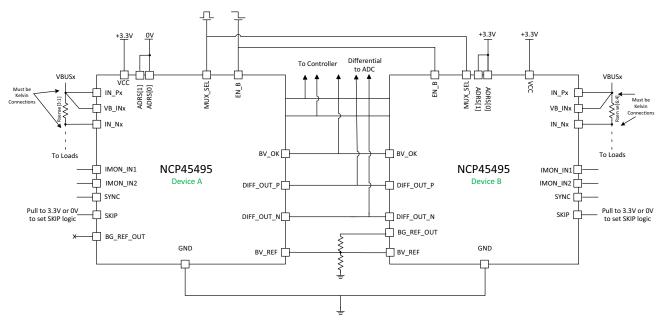


Figure 12. Six-Channel Paired Devices Connection Diagram

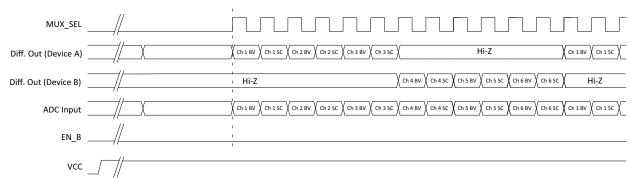


Figure 13. Six-Channel Paired Device Signal Characteristics with 6 Channels Activated

The following example shows the output sequence when all channels are active with a ground reference and alternating mode enabled in paired mode. The register settings for each device are shown below.

| DEVICE A (I <sup>2</sup> C | address: 0x34)                    | DEVICE B (I <sup>2</sup> C Address: 0x35) |                  |  |
|----------------------------|-----------------------------------|---|------------------|--|
| Register Address           | Register Address Register Setting |   | Register Setting |  |
| 0x04 0xBF                  |                                   | 0x04                                      | 0xBF             |  |
| 0x05                       | 0x0B                              | 0x05                                      | 0xB0             |  |
| 0x06                       | 0x80                              | 0x06                                      | 0x80             |  |

| Clock Cycle | Diff Output (Device A)      | Diff Output (Device B)                                |
|-------------|-----------------------------|---|
| 0           | High Z                      | High Z  |
| 1           | Ch 1 Bus Voltage            | High Z  |
| 2           | Ch 1 Shunt Current          | High Z  |
| 3           | Ch 2 Bus Voltage            | High Z  |
| 4           | Ch 2 Shunt Current          | High Z  |
| 5           | Ch 3 Bus Voltage            | High Z  |
| 6           | Ch 3 Shunt Current          | High Z  |
| 7           | Ch 4 Bus Voltage            | High Z  |
| 8           | Ch 4 Shunt Current          | High Z  |
| 9           | iMon1                       | High Z  |
| 10          | iMon2                       | High Z  |
| 11          | Ref GND                     | High Z  |
| 12          | High Z                      | Ch 1 Bus Voltage                                      |
| 13          | High Z                      | Ch 1 Shunt Current                                    |
| 14          | High Z                      | Ch 2 Bus Voltage                                      |
| 15          | High Z                      | Ch 2 Shunt Current                                    |
|             |                             |   |
| 16          | High Z                      | Ch 3 Bus Voltage                                      |
| 17          | High Z                      | Ch 3 Shunt Current                                    |
| 18          | High Z                      | Ch 4 Bus Voltage                                      |
| 19          | High Z                      | Ch 4 Shunt Current                                    |
| 20          | High Z                      | iMon1   |
| 21          | High Z                      | iMon2   |
| 22          | High Z                      | Ref GND   |
| 23          | Ch 1 Bus Voltage Reversed   | High Z  |
| 24          | Ch 1 Shunt Current Reversed | High Z  |
| 25          | Ch 2 Bus Voltage Reversed   | High Z  |
| 26          | Ch 2 Shunt Current Reversed | High Z  |
| 27          | Ch 3 Bus Voltage Reversed   | High Z  |
| 28          | Ch 3 Shunt Current Reversed | High Z  |
| 29          | Ch 4 Bus Voltage Reversed   | High Z  |
| 30          | Ch 4 Shunt Current Reversed | High Z  |
| 31          | iMon1 Reversed              | High Z  |
| 32          | iMon2 Reversed              | High Z  |
| 33          | Ref GND Reversed            | High Z  |
| 34          | High Z                      | Ch 1 Bus Voltage Reversed                             |
| 35          | High Z                      | Ch 1 Shunt Current Reversed                           |
| 36          |                             |   |
| 37          | High Z                      | Ch 2 Bus Voltage Reversed Ch 2 Shunt Current Reversed |
|             | High Z                      |   |
| 38          | High Z                      | Ch 3 Bus Voltage Reversed                             |
| 39          | High Z                      | Ch 3 Shunt Current Reversed                           |
| 40          | High Z                      | Ch 4 Bus Voltage Reversed                             |
| 41          | High Z                      | Ch 4 Shunt Current Reversed                           |
| 42          | High Z                      | iMon1 Reversed  |
| 43          | High Z                      | iMon2 Reversed  |
| 44          | High Z                      | Ref GND Reversed                                      |
| 45          | Ch 1 Bus Voltage            | High Z  |

#### **AUXILIARY FUNCTIONS**

Bus Comparator (BV\_OK): The BV\_OK pin provides a real-time indication that  $V_{CC}$  and all bus voltages (as measured on the BV\_INx pins) are valid. BV\_OK remains low until all used BV\_INx pins are above a user-defined threshold voltage. The BV\_OK threshold is set by an external resistor divider on the BV\_REF pin. The internal BV\_OK comparator has built in hysteresis of 10% to prevent chatter as voltage busses come up. All channels specified in the ACTIVE\_CHAN register will be represented. If desired, the user can use the SKIP pin to modify the logic as shown in the corresponding table (H = high, L = low, Z = tristate, X = don't care). The SKIP pin can also be used to hold BV\_OK = L in the absence of  $V_{CC}$ .

| VCC | EN_B | VB_INx | SKIP | BV_OK         | Notes             |
|-----|------|--------|------|---------------|-------------------|
| L   | L    | Х      | L    | open          | No Power          |
|     |      |        |      | drain         | Provided to Part  |
|     |      |        |      |               | SKIP Pin Provides |
| L   | L    | Х      | Н    | L             | Power Needed to   |
|     |      |        |      |               | Hold BV_OK Low    |
| Н   | Н    | Х      | L    | open<br>drain | Standby Mode      |
| Н   | Н    | Χ      | Н    | L             | Standby Mode      |
| Н   | Z/L  | L      | Н    | L             | Functional or     |
|     |      |        |      |               | Limited Mode      |
| Н   | Z/L  | Н      | Н    | open          | Functional or     |
|     |      |        |      | drain         | Limited Mode      |
| Н   | Z/L  | Х      | L    | open          | Functional or     |
|     |      |        |      | drain         | Limited Mode      |

Reset/Timeout: If the timeout is enabled, holding the MUX\_SEL pin LOW longer than 43 µs will reset to the beginning of the MUX\_SEL sequence. If the timeout has been disabled, then the MUX\_SEL must cycle through all set channels to return to the beginning of the sequence. Toggling the EN\_B pin will also reset the sequence back to the beginning.

**Bandgap Reference:** The BG\_REF\_OUT pin provides a high-accuracy voltage that can be used to generate the BV\_REF voltage for the BV\_OK comparators.

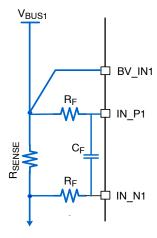
**Enable Function:** The EN\_B pin controls device operation according to the corresponding table.

# **EN B LOGIC**

| Level                   | Device Operation   |
|-------------------------|--|
| LOW                     | Fully Functional   |
| Tri-state<br>(floating) | Limited Function: BG_REF_OUT is valid, BV_OK comparators and output are functional. All other functions to be disabled. DIFF_OUT to be Hi-Z and multiplexer select logic is held in reset. |
| HIGH                    | Standby: Power down state. Nothing is active.  |

# Input Filtering:

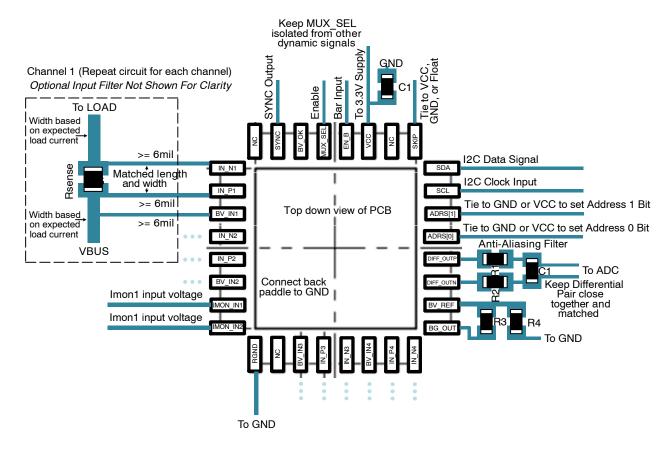
If additional filtering is needed on the input bus lines, external filtering can be added as shown below.



Mismatch between the 2  $R_F$  values will contribute to the overall measurement offset error. To avoid this, the tolerance of external  $R_F$  resistors should be < 1%. External  $R_F$  values should not exceed 20 k $\Omega$ .

# **Layout Considerations**

Sensitive signals that require special attention in board layout include the channel inputs (IN\_N, IN\_P, and BV\_IN signals), the differential output signals, and the MUX\_SEL signal. The IN\_N and IN\_P signals require a direct kelvin connection to the leads of the sense resistor to avoid parasitic trace resistance affecting the shunt current measurement. This direct connection is shown below. The sense resistors and connections from source to load for each channel need to be large enough to accommodate the expected high load currents.



Care should be taken to keep DIFF\_OUT\_P and DIFF\_OUT\_N matched. As a differential pair, any noise introduced to the pair will be common and will be rejected if the signals are close together and matched in length. Care should be taken to keep the MUX\_SEL line isolated from other dynamically changing signals.

# **Unused Channels**

Unused channels should be disabled by setting Register 0x04 over I<sup>2</sup>C. The IN\_P and IN\_N pins for an unused channel should have the same connection. The following table details the recommended connections for unused pins.

| Unused Pins | Connection  |  |
|-------------|---|--|
| BV_INx      | Connect to BV_IN pin of a previous channel or GND |  |
| IN_Px       | Connect to the same potential as BV_INx or        |  |
| IN_Nx       | Float   |  |
| IMONx       | Float or GND                                      |  |
| SYNC        | Float   |  |

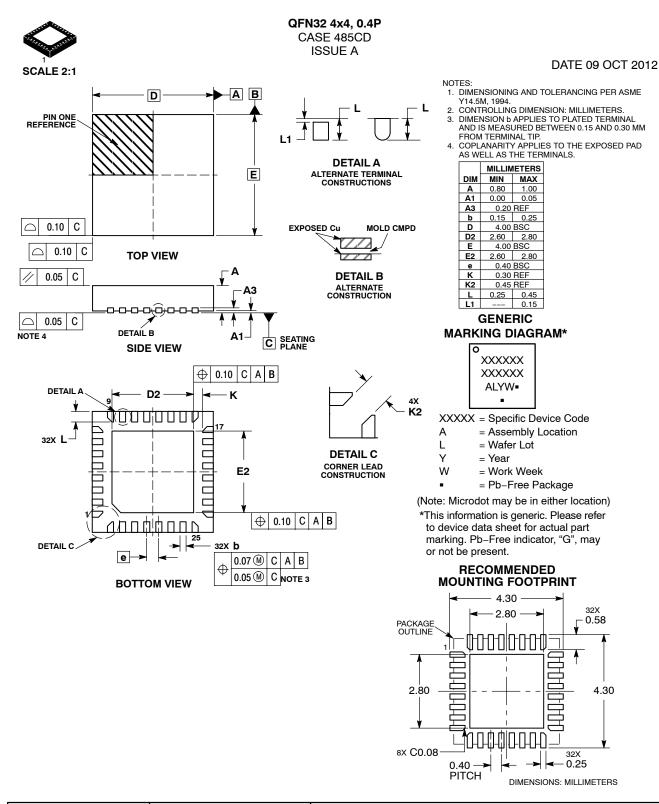
# **REVISION HISTORY**

| Revision | Description of Changes  | Date      |
|----------|---|-----------|
| 5        | Edits to the EC table, add note 12, replace a sentence on page 7, replace figures 3 and 4, edits to table 8, edits to figures 6 and 7, delete a sentence page 10, replace a sentence on page 16 | 7/11/2025 |

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.







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